



#### 80V +175°C N-CHANNEL ENHANCEMENT MODE MOSFET

### **Product Summary**

BV <sub>DSS</sub>	R <sub>DS(ON)</sub> Max	I <sub>D</sub> Max T <sub>A</sub> = +25°C
901/	22mΩ @ V <sub>GS</sub> = 10V	5A
80V	38mΩ @ V <sub>GS</sub> = 4.5V	4A

### **Features and Benefits**

- 100% Unclamped Inductive Switching (UIS) Test in Production Ensures More Reliable and Robust End Application
- Thermally Efficient Package Cooler Running Applications
- High Conversion Efficiency
- Low R<sub>DS(ON)</sub> Minimizes On-State Losses
- Low Input Capacitance
- Fast Switching Speed
- < 1.1mm Package Profile Ideal for Thin Applications</li>
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- An automotive-compliant part is available under a separate datasheet (<u>DMTH8022LFDFWQ</u>)

### **Description and Applications**

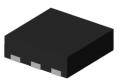
This new generation MOSFET is designed to minimize the on-state resistance (R<sub>DS(ON)</sub>) yet maintain superior switching performance, making it ideal for high-efficiency power-management applications.

- Power-management functions
- Battery-operated systems and solid-state relays
- Drivers: relays, solenoids, lamps, hammers, displays, memories, transistors, etc.

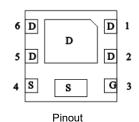
### **Mechanical Data**

- Package: U-DFN2020-6
- Package Material: Molded Plastic, "Green" Molding Compound.
   UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Solderable per MIL-STD-202, Method 208 (e3)
- Weight: 0.008 grams (Approximate)

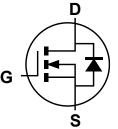
#### U-DFN2020-6/SWP (Type F)







**Bottom View** 



Top View

**Bottom View** 

Internal Schematic

### **Ordering Information** (Note 4)

Orderable Part Number	Package	Packing		
Orderable Part Number	Package	Qty.	Carrier	
DMTH8022LFDFW-7	U-DFN2020-6/SWP (Type F)	3,000	Reel	
DMTH8022LFDFW-13	U-DFN2020-6/SWP (Type F)	10,000	Reel	

Notes:

- 1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.



## **Marking Information**



80 = Product Type Marking Code YM = Date Code Marking Y = Year (ex: M = 2025) M = Month (ex: 2 = February)

#### Date Code Key

Year	2025	2026	2027	2028	2029	2030	2031	2032	2033	2034	2035	2036
Code	М	N	Р	R	S	Т	U	V	W	Х	Υ	Z
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D

## Maximum Ratings (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Drain-Source Voltage	$V_{DSS}$	80	V	
Gate-Source Voltage	$V_{GSS}$	±20	V	
Continuous Drain Current, V <sub>GS</sub> = 10V (Note 5)	T <sub>A</sub> = +25°C T <sub>A</sub> = +100°C	Ιο	5 3.5	А
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)	I <sub>DM</sub>	52	Α	
Maximum Body Diode Continuous Current (Note 5)	ls	3.4	Α	
Pulsed Body Diode Current (10µs Pulse, Duty Cycle = 1%	lsм	52	Α	
Avalanche Current, L = 1mH	las	8.7	Α	
Avalanche Energy, L = 1mH	Eas	39	mJ	

## Thermal Characteristics (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Total Power Dissipation (Note 6)	P <sub>D</sub>	1.16	W
Thermal Resistance, Junction to Ambient (Note 6)	Reja	129	°C/W
Total Power Dissipation (Note 5)	PD	2.5	W
Thermal Resistance, Junction to Ambient (Note 5)	RθJA	60	°C/W
Operating and Storage Temperature Range	TJ, TSTG	-55 to +175	°C

Notes:

<sup>5.</sup> Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.6. Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.



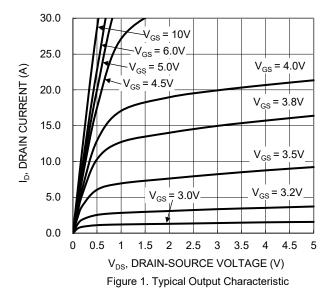
# Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)							
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	80	_	_	V	V <sub>GS</sub> = 0, I <sub>D</sub> = 1mA	
Zero Gate Voltage Drain Current	IDSS	-	-	1	μA	V <sub>DS</sub> = 64V, V <sub>GS</sub> = 0	
Gate-Source Leakage	Igss	-	-	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0$	
ON CHARACTERISTICS (Note 7)							
Gate Threshold Voltage	Vgs(TH)	1.3	_	2.5	V	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 250μA	
Static Drain-Source On-Resistance	D	_	16	22	mΩ	V <sub>GS</sub> = 10V, I <sub>D</sub> = 5A	
Static Drain-Source On-Resistance	R <sub>DS(ON)</sub>	_	25	38	11122	$V_{GS} = 4.5V, I_D = 4A$	
Diode Forward Voltage	VsD	-	0.8	1.0	V	V <sub>GS</sub> = 0, I <sub>S</sub> = 10A	
DYNAMIC CHARACTERISTICS (Note 8)							
Input Capacitance	C <sub>iss</sub>	_	591	_	pF	.,	
Output Capacitance	Coss	ı	214	_	n- I	$V_{DS} = 40V$ , $V_{GS} = 0$ f = 1MHz	
Reverse Transfer Capacitance	Crss	_	15	_	pF	1 - 1101112	
Gate Resistance	Rg	_	1.38	_	Ω	V <sub>DS</sub> = 0, V <sub>GS</sub> = 0, f = 1MHz	
Total Gate Charge (V <sub>GS</sub> = 4.5V)	Qg	-	5.6	_	nC		
Total Gate Charge (V <sub>GS</sub> = 10V)	Qg	ı	11.3	_	nC	V <sub>DS</sub> = 40V. I <sub>D</sub> = 7.5A	
Gate-Source Charge	Qgs	ı	2.6	_	nC	VDS - 40V, ID - 7.5A	
Gate-Drain Charge	$Q_{gd}$	_	2.3	_	nC		
Turn-On Delay Time	t <sub>D(ON)</sub>	_	13	_	ns		
Turn-On Rise Time	t <sub>R</sub>	-	34	_	ns	V <sub>DD</sub> = 40V	
Turn-Off Delay Time	t <sub>D(OFF)</sub>	_	11	_	ns	$V_{GS} = 4.5V, R_g = 2.7\Omega$ $I_D = 10A$	
Turn-Off Fall Time	tϝ	_	13	_	ns		
Reverse-Recovery Time	t <sub>RR</sub>	_	24	_	ns	I 7 FA di/dt _ 100 A/us	
Reverse-Recovery Charge	Qrr	_	14	_	nC	I <sub>F</sub> = 7.5A, di/dt = 100A/μs	

Notes:

<sup>7.</sup> Short duration pulse test used to minimize self-heating effect. 8. Guaranteed by design. Not subject to product testing.





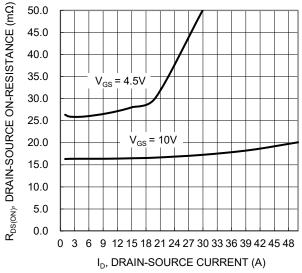


Figure 3. Typical On-Resistance vs. Drain Current and Gate Voltage

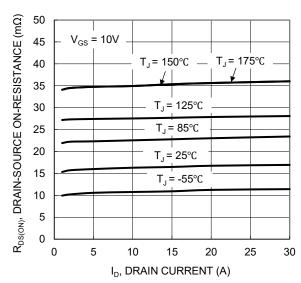


Figure 5. Typical On-Resistance vs. Drain Current and Temperature

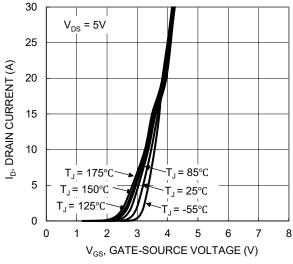


Figure 2. Typical Transfer Characteristic

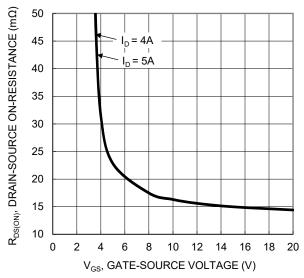


Figure 4. Typical Transfer Characteristic

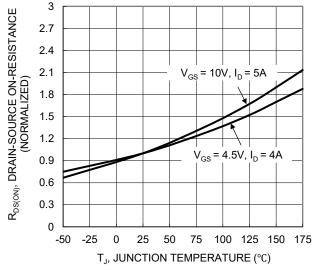


Figure 6. On-Resistance Variation with Temperature



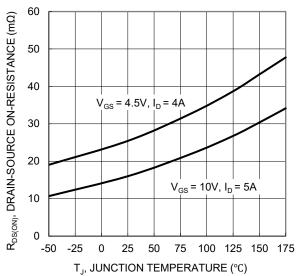


Figure 7. On-Resistance Variation with Temperature

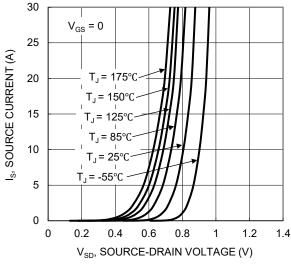


Figure 9. Diode Forward Voltage vs. Current

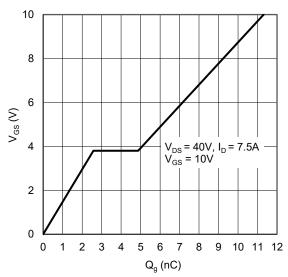


Figure 11. Gate Charge

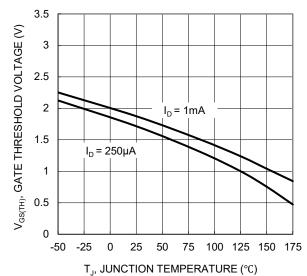


Figure 8. Gate Threshold Variation vs. Junction Temperature

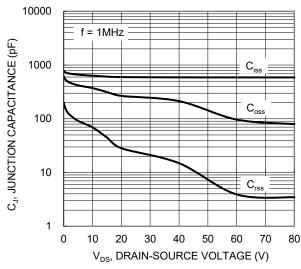


Figure 10. Typical Junction Capacitance

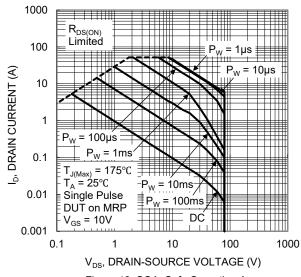


Figure 12. SOA, Safe Operation Area



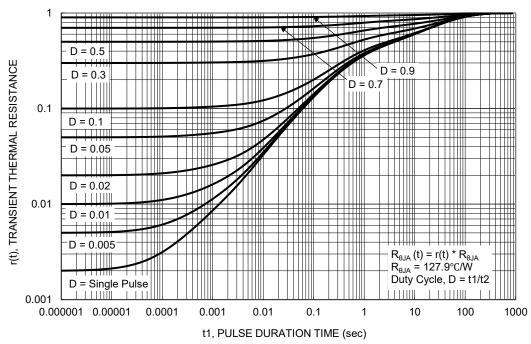


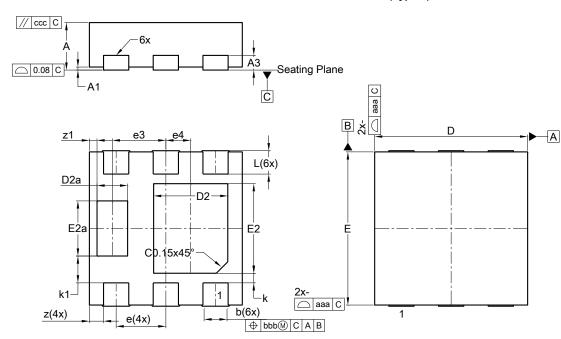
Figure 13. Transient Thermal Resistance



## **Package Outline Dimension**

Please see http://www.diodes.com/package-outlines.html for the latest version.

#### U-DFN2020-6/SWP (Type F)

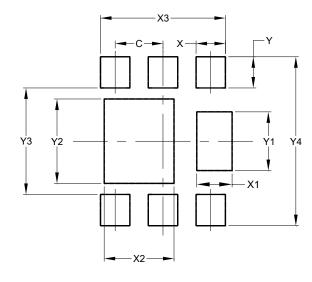


U-DFN2020-6/SWP (Type F)						
Dim	Min	Тур				
Α	0.59	0.65	0.62			
A1	0.00	0.05	0.03			
А3	-	-	0.192			
b	0.28	0.38	0.33			
D	1.95	2.05	2.00			
D2	0.87	1.07	0.97			
D2a	0.35	0.45	0.40			
Е	1.95	2.05	2.00			
E2	1.07	1.27	1.17			
E2a	0.67	0.77	0.72			
е	0.65 BSC					
е3	0.70 BSC					
e4	0	.325 BS	С			
k			0.125			
k1			0.35			
L	0.225	0.355	0.305			
Z	ı	ı	0.185			
z1	-	-	0.10			
aaa	0.250					
bbb	0.100					
CCC	0.100					
All Dimensions in mm						

# **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.

#### U-DFN2020-6/SWP (Type F)



Dimensions	Value (in mm)		
С	0.650		
X	0.400		
X1	0.480		
X2	0.950		
Х3	1.700		
Y	0.425		
Y1	0.800		
Y2	1.150		
Y3	1.450		
Y4	2.300		



#### **IMPORTANT NOTICE**

- 1. DIODES INCORPORATED (Diodes) AND ITS SUBSIDIARIES MAKE NO WARRANTY OF ANY KIND, EXPRESS OR IMPLIED, WITH REGARDS TO ANY INFORMATION CONTAINED IN THIS DOCUMENT, INCLUDING, BUT NOT LIMITED TO, THE IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE OR NON-INFRINGEMENT OF THIRD PARTY INTELLECTUAL PROPERTY RIGHTS (AND THEIR EQUIVALENTS UNDER THE LAWS OF ANY JURISDICTION).
- 2. The Information contained herein is for informational purpose only and is provided only to illustrate the operation of Diodes' products described herein and application examples. Diodes does not assume any liability arising out of the application or use of this document or any product described herein. This document is intended for skilled and technically trained engineering customers and users who design with Diodes' products. Diodes' products may be used to facilitate safety-related applications; however, in all instances customers and users are responsible for (a) selecting the appropriate Diodes products for their applications, (b) evaluating the suitability of Diodes' products for their intended applications, (c) ensuring their applications, which incorporate Diodes' products, comply the applicable legal and regulatory requirements as well as safety and functional-safety related standards, and (d) ensuring they design with appropriate safeguards (including testing, validation, quality control techniques, redundancy, malfunction prevention, and appropriate treatment for aging degradation) to minimize the risks associated with their applications.
- 3. Diodes assumes no liability for any application-related information, support, assistance or feedback that may be provided by Diodes from time to time. Any customer or user of this document or products described herein will assume all risks and liabilities associated with such use, and will hold Diodes and all companies whose products are represented herein or on Diodes' websites, harmless against all damages and liabilities.
- 4. Products described herein may be covered by one or more United States, international or foreign patents and pending patent applications. Product names and markings noted herein may also be covered by one or more United States, international or foreign trademarks and trademark applications. Diodes does not convey any license under any of its intellectual property rights or the rights of any third parties (including third parties whose products and services may be described in this document or on Diodes' website) under this document.
- 5. Diodes' products are provided subject to Diodes' Standard Terms and Conditions of Sale (https://www.diodes.com/about/company/terms-and-conditions/terms-and-conditions-of-sales/) or other applicable terms. This document does not alter or expand the applicable warranties provided by Diodes. Diodes does not warrant or accept any liability whatsoever in respect of any products purchased through unauthorized sales channel.
- 6. Diodes' products and technology may not be used for or incorporated into any products or systems whose manufacture, use or sale is prohibited under any applicable laws and regulations. Should customers or users use Diodes' products in contravention of any applicable laws or regulations, or for any unintended or unauthorized application, customers and users will (a) be solely responsible for any damages, losses or penalties arising in connection therewith or as a result thereof, and (b) indemnify and hold Diodes and its representatives and agents harmless against any and all claims, damages, expenses, and attorney fees arising out of, directly or indirectly, any claim relating to any noncompliance with the applicable laws and regulations, as well as any unintended or unauthorized application.
- 7. While efforts have been made to ensure the information contained in this document is accurate, complete and current, it may contain technical inaccuracies, omissions and typographical errors. Diodes does not warrant that information contained in this document is error-free and Diodes is under no obligation to update or otherwise correct this information. Notwithstanding the foregoing, Diodes reserves the right to make modifications, enhancements, improvements, corrections or other changes without further notice to this document and any product described herein. This document is written in English but may be translated into multiple languages for reference. Only the English version of this document is the final and determinative format released by Diodes.
- 8. Any unauthorized copying, modification, distribution, transmission, display or other use of this document (or any portion hereof) is prohibited. Diodes assumes no responsibility for any losses incurred by the customers or users or any third parties arising from any such unauthorized use.
- 9. This Notice may be periodically updated with the most recent version available at <a href="https://www.diodes.com/about/company/terms-and-conditions/important-notice">https://www.diodes.com/about/company/terms-and-conditions/important-notice</a>

The Diodes logo is a registered trademark of Diodes Incorporated in the United States and other countries. All other trademarks are the property of their respective owners.

© 2025 Diodes Incorporated. All Rights Reserved.

www.diodes.com